

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Date: 05/10/01

Applicant: Charles W.C. Lin
Title: BUMPLESS FLIP CHIP ASSEMBLY WITH SOLDER VIA
Express Mail No: EK770854597US
Atty Docket No.: P002-2



Documents Enclosed:

Transmittal (2 pages)

Prior Application

Specification (8 pages), Claims (3 pages), Abstract (1 page), Drawings (4 sheets)

Prior Declaration (2 pages)

Preliminary Amendment (11 pages)

Substitute Specification (cover sheet plus 8 pages)

Substitute Specification -Changes Shown (cover sheet plus 10 pages)

Submission of Proposed Drawing Amendment for Approval by Examiner (2 pages)

Information Disclosure Statement (2 pages)

PTO-1449 (9 pages)

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Assistant Commissioner for Patents
Washington, D.C. 20231

Date: 01/28/02

Applicant: Charles W.C. Lin
Title: BUMPLESS FLIP CHIP ASSEMBLY WITH SOLDER V.A
Serial No.: 09/852,824
Filed: May 10, 2001
Docket No.: P002-2

Documents Enclosed:

Information Disclosure Statement (2 pages)

PTO-1449 (1 page)

Seven References

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